

NOTE:

1.MATERIAL SPECIFICATION:

- 1.HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.
- 2.CONTACTS:COPPER ALLOY
- 3.MID PLATE: STAINLESS STEEL
- 4.FRONT SHELL: STAINLESS STEEL

2.PLATING SPECIFICATION:

- 2-1.CONTACTS:  
Ni 50μ" MIN. UNDER PLATED OVER ALL.  
Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.  
(GOLD PLATING THICKNESS FOLLOW THE P/N)  
PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N

2-2.FRONT SHELL:

SEE TABLE 1.

2-3.SHIELD PLATE&EMI PLATE:

CLEAR ONLY

3.MECHANICAL PERFORMANCE,

- 3-1.INSERTION FORCE: 0.5~2.0kgf.
- 3-2.REMOVAL FORCE: 0.8kgf~2.0kgf.
- 3-3.DURABILITY: 5000 CYCLES.

4.ELECTRICAL PERFORMANCE,

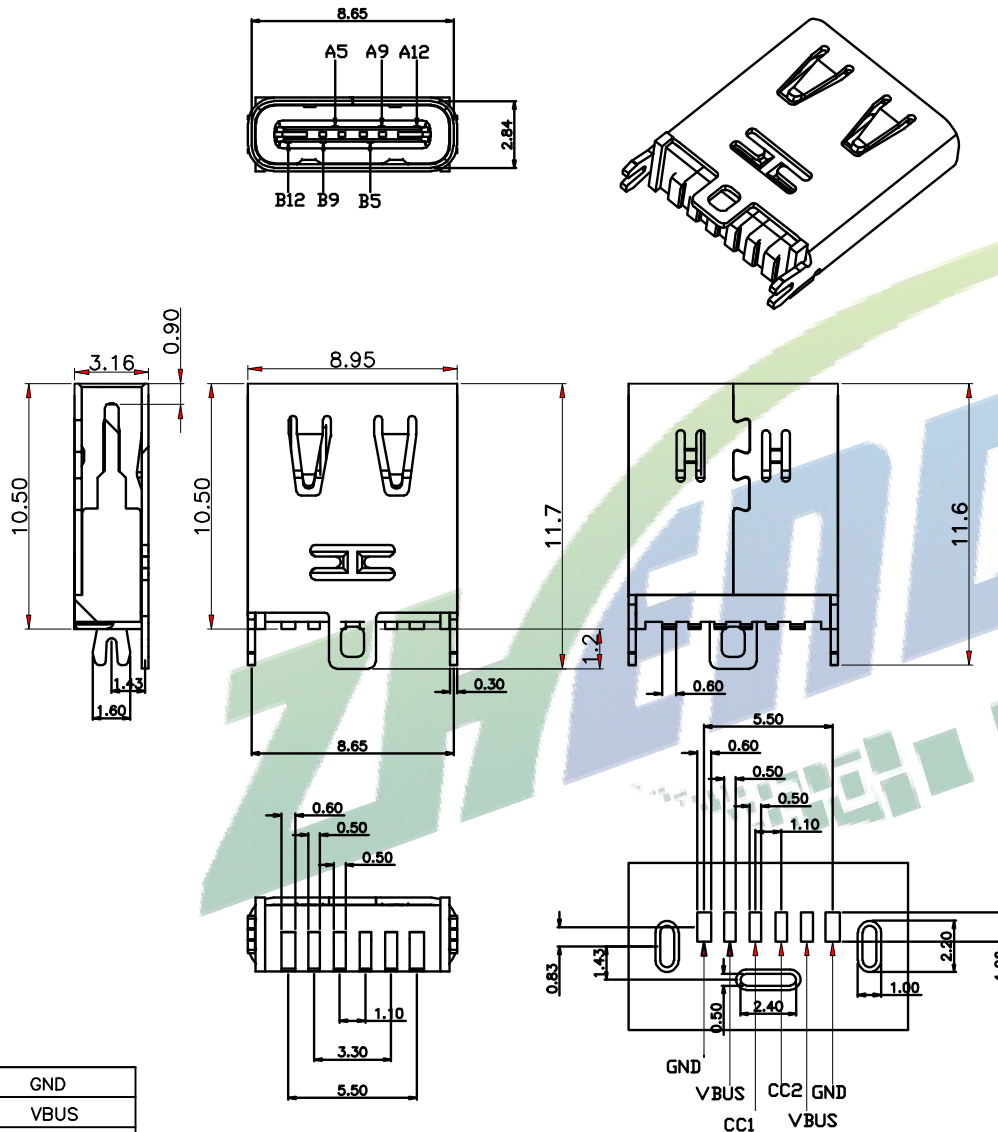
- 4-1. CURRENT RATING: 3.0A  
VOLTAGE RATING: 5.0V
- 4-2. LLCR:  
VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.  
SHIELD: 50mΩ/MAX.  
LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
- 4-3.INSULATION RESISTANCE: 100MΩ MIN
- 4-4.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.

5. ENVIRONMENTAL PERFORMANCE:

OPERATING TEMPERATURE: -25°C~+85°C.

6.IR REFLOW:

THE PEAK TEMPERATURE ON THE BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260°C.



B12	GND
B9	VBUS
B5	CC2
A5	CC1
A9	VBUS
A12	GND
PIN	SIGNAL NAME

<b>振端精密科技 (深圳) 有限公司</b> Zhenduan precision technology (Shenzhen) Co., Ltd			
TOLERANCE: X.X ±0.30 X.XX ±0.20 X.XXX ±0.10 X. ±10° X. ° X. °	DRAWN BY : <b>刘志强</b>	DATE : 2015.08.18	PART NAME: <b>TYPE-C6P立式贴板H10.5</b>
UNIT: mm [inch] SCALE: 1:1 SIZE: A4	CHECKED BY: <b>李文毅</b>	DATE : 2015.08.18	PART NO. SEE TABLE MOLD NO.
	APPROVED BY: <b>张少辉</b>	DATE : 2015.08.18	DRAW NO: <b>ZDJNKJ00000010</b> SHEET NO. 1 OF 1